

12-28-00  
A

12/26/00  
S. PTO  
1992

|   |  |                        |
|---|--|------------------------|
| PATENT APPLICATION TRANSMITTAL LETTER<br>(Large Entity) |  | Docket No.<br>E0520CIP |
|---|--|------------------------|

TO THE ASSISTANT COMMISSIONER FOR PATENTS

12/26/00  
S. PTO  
1992

Transmitted herewith for filing under 35 U.S.C. 111 and 37 C.F.R. 1.53 is the patent application of:

Kashmir S. Sahota, Diana M. Schonauer, Johannes F. Groschopf, Gerd F. C. Marxsen, Steven A. Avanzino

For: "PREVENTION OF PRECIPITATION DEFECTS ON COPPER INTERCONNECTS DURING CMP BY USE OF SOLUTIONS CONTAINING ORGANIC COMPOUNDS WITH SILICA ADSORPTION AND COPPER CORROSION INHIBITING PROPERTIES"

Enclosed are:

- Certificate of Mailing with Express Mail Mailing Label No. EL184649886US
- 12 (twelve) sheets of drawings.
- A certified copy of a application.
- Declaration  Signed.  Unsigned.
- Power of Attorney
- Information Disclosure Statement
- Preliminary Amendment
- Other: Recordation Cover Sheet and Assignment; Request and Certification under 35 USC 122(b)(2)(B)(i)

CLAIMS AS FILED

| For   | #Filed                   | #Allowed | #Extra | Rate             | Fee        |
|---|--------------------------|----------|--------|------------------|------------|
| Total Claims                                    | 73                       | - 20 =   | 53     | x \$18.00        | \$954.00   |
| Indep. Claims                                   | 5                        | - 3 =    | 2      | x \$80.00        | \$160.00   |
| Multiple Dependent Claims (check if applicable) | <input type="checkbox"/> |          |        |                  | \$0.00     |
|   |                          |          |        | BASIC FEE        | \$710.00   |
|   |                          |          |        | TOTAL FILING FEE | \$1,824.00 |

- A check in the amount of to cover the filing fee is enclosed.
- The Commissioner is hereby authorized to charge and credit Deposit Account No. 01-0365 as described below. A duplicate copy of this sheet is enclosed.
- Charge the amount of \$1,824.00 as filing fee.
- Credit any overpayment.
- Charge any additional filing fees required under 37 C.F.R. 1.16 and 1.17.
- Charge the issue fee set in 37 C.F.R. 1.18 at the mailing of the Notice of Allowance, pursuant to 37 C.F.R. 1.311(b).

Dated: December 26, 2000

Deborah W. Wenocur  
Signature

Deborah W. Wenocur, Reg. No 40,221  
Agent for Applicant  
Advanced Micro Devices, Inc.  
Technology Law Dept. M/S 68  
One AMD Place  
P.O. Box 3453  
Sunnyvale, CA 94088-3453

CC:



12/26/00

**TRANSMITTAL LETTER  
(General - Patent Pending)**
Docket No.  
E0520CIP

In Re Application Of: **Kashmir S. Sahota, Diana M. Schonauer, Johannes F. Groschopf, Gerd F.C. Marxsen, Steven A. Avanzino**

Serial No.

Filing Date

Examiner

Group Art Unit

**Title: "PREVENTION OF PRECIPITATION DEFECTS ON COPPER INTERCONNECTS DURING CMP BY USE  
SOLUTIONS CONTAINING ORGANIC COMPOUNDS WITH SILICA ADSORPTION AND COPPER CORROSION  
INHIBITING PROPERTIES"**

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is: **Patent Application Transmittal Letter (in duplicate)**

**Certificate of Mailing by Express Mail with Express Mail Mailing Label No. EL184649866US**

**Patent Specification for CIP Application filed under 37 CFR 1.53(b), including Claims and Abstract (53 pp)**

**Declaration and Power of Attorney (4 pp)**

**12 (twelve) sheets of drawings**

**Recordation Cover Sheet and Assignment (5 pp); Request and Certification under 35 USC 122(b)b92)(B)(i)**

in the above identified application.

- No additional fee is required.
- A check in the amount of \_\_\_\_\_ is attached.
- The Assistant Commissioner is hereby authorized to charge and credit Deposit Account No. **01-0365** as described below. A duplicate copy of this sheet is enclosed.
  - Charge the amount of **\$1,824.00**
  - Credit any overpayment.
  - Charge any additional fee required.

Deborah W. Wenocur  
*Signature*

Dated: December 26, 2000

**Deborah W. Wenocur, Reg. No. 40,221**  
**Agent for Applicant**  
**Advanced Micro Devices, Inc.**  
**Technology Law Dept. M/S 68**  
**One AMD Place**  
**P.O. Box. 3453**  
**Sunnyvale, CA 94088-3453**

I certify that this document and fee is being deposited on Dec. 26, 2000 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

Deborah W. Wenocur  
*Signature of Person Mailing Correspondence*

cc:

**Deborah W. Wenocur***Typed or Printed Name of Person Mailing Correspondence*

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number.

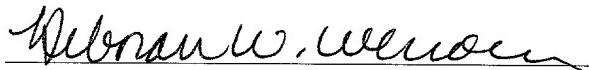
**REQUEST AND CERTIFICATION  
UNDER  
35 U.S.C. 122(b)(2)(B)(i)**

|                      |  |
|----------------------|--|
| First Named Inventor | Kashmir S. Sahota  |
| Title                | Prevention of Precipitation Defects on Copper Interconnects During CMP By Use of Solutions ... |
| Atty Docket Number   | E0520CIP   |

I hereby certify that the invention disclosed in the attached application **has not and will not be** the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

December 25, 2000

Date



Signature

Deborah W. Wenocur

Typed or printed name

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant **must** notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. **Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).**